

LOW CURRENT LNA/MIXER

## Typical Applications

- UHF Digital and Analog Receivers
- Digital Communication Systems
- Spread-Spectrum Communication Systems
   General Purpose Frequency Conversion
- Commercial and Consumer Systems
- 433MHz and 915MHz ISM Band Receivers

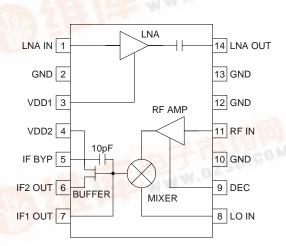
## **Product Description**

The RF2418 is a monolithic integrated UHF receiver front-end. The IC contains all of the required components to implement the RF functions of the receiver except for the passive filtering and LO generation. It contains an LNA (low-noise amplifier), a second RF amplifier, a dualgate GaAs FET mixer, and an IF output buffer amplifier which will drive a  $50\Omega$  load. In addition, the IF buffer amplifier may be disabled and a high impedance output is provided for easy matching to IF filters with high impedances. The output of the LNA is made available as an output to permit the insertion of a bandpass filter between the LNA and the RF/Mixer section. The LNA section may be disabled by removing the VDD1 connection to the IC.

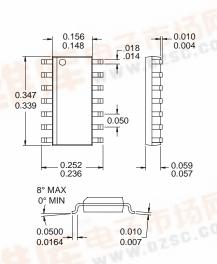
Optimum Technology Matching® Applied

Si BJT Si Bi-CMOS GaAs HBT SiGe HBT

**▼** GaAs MESFET Si CMOS



Functional Block Diagram



Package Style: SOIC-14

### **Features**

- Single 3V to 6.5V Power Supply
- High Dynamic Range
- Low Current Drain
- High LO Isolation
- LNA Power Down Mode for Large Signals

#### Ordering Information

RF2418

Low Current LNA/Mixer

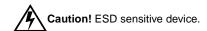
RF2418 PCBA Fully Assembled Evaluation Board

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## **Absolute Maximum Ratings**

Parameter	Rating	Unit			
Supply Voltage	-0.5 to 7	$V_{DC}$			
Input LO and RF Levels	+6	dBm			
Ambient Operating Temperature	-40 to +85	°C			
Storage Temperature	-40 to +150	°C			



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Parameter		<b>Specification</b>	1	Unit	Condition	
Parameter	Min.	Тур.	Max.	Unit		
Overall					T=25°C, V <sub>CC</sub> =5V, RF=850MHz,	
					LO=921MHz	
RF Frequency Range		400 to 1100		MHz		
Cascade Power Gain		23		dB	High impedance output	
Cascade IP <sub>3</sub>		-13		dBm	Referenced to the input	
Cascade Noise Figure		2.4		dB	Single sideband, includes image filter with 1.0dB insertion loss	
First Section (LNA)					1.5 dB insertion less	
Noise Figure		1.8	2.0	dB		
Input VSWR		1.5:1			With external series matching inductor	
Input IP3	+3.0	+4.0		dBm	ů .	
Gain	13	14		dB		
Reverse Isolation		40		dB		
Output VSWR		1.5:1				
Second Section (RF Amp,					High impedance output	
Mixer, IF1)						
Noise Figure		9.5		dB	Single Sideband	
Input VSWR		1.5:1			With external series matching inductor	
Input IP3		+1		dBm		
Conversion Power Gain	7	9		dB		
Output Impedance		4000  10pF		Ω	Open Collector	
Second Section (RF Amp,					Buffered output, 50Ω load	
Mixer, IF2)						
Noise Figure		10		dB	Single Sideband	
Input VSWR		1.5:1			With external series matching inductor	
Input IP3	-0.5	0		dBm	· ·	
Conversion Gain	5	6		dB		
Output Impedance		30		Ω		
LO Input						
LO Frequency		300 to 1200		MHz		
LO Level		-6 to +6		dBm		
LO to RF Rejection		15		dB		
LO to IF Rejection		40		dB	With pin 5 connected to ground.	
LO Input VSWR		1.3:1			In order to achieve a low VSWR match at	
					this input, an $82\Omega$ resistor to ground is	
Dower Cumply					placed in parallel with this port.	
Power Supply	2.0		0.5	.,		
Voltage	3.0	4.4	6.5	V	V 50V I NIA On Minor On D " O"	
Current Consumption		14		mA	V <sub>CC</sub> =5.0 V, LNA On, Mixer On, Buffer Off	
	12	20	26	mA	V <sub>CC</sub> =5.0 V, LNA On, Mixer On, Buffer On	
	6	9	20	mA	V <sub>CC</sub> =5.0 V, LNA Off, Mixer On, Buffer Off	

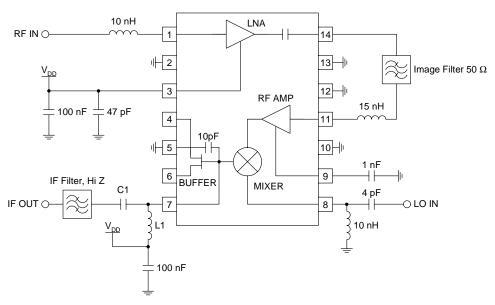
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Pin	Function	Description	Interface Schematic
1	LNA IN	A series 10nH matching inductor is necessary to achieve specified gain and noise figure at 900MHz. This pin is NOT internally DC-blocked. An external blocking capacitor must be provided if the pin is connected to a device with DC present. A DC path to ground (i.e. an inductor or resistor to ground) is, however, acceptable at this pin. If a blocking capacitor is required, a value of 22pF is recommended.	LNA IN O
2	GND	Ground connection. Keep traces physically short and connect immediately to ground plane for best performance.	
3	VDD1	Supply Voltage for the LNA only. A 22pF external bypass capacitor is required and an additional 0.01 µF is required if no other low frequency bypass capacitors are near by. The trace length between the pin and the bypass capacitors should be minimized. The ground side of the bypass capacitors should connect immediately to ground plane.  For large input signals, VDD1 may be disconnected, resulting in the LNA's gain changing from +11 dB to -26 dB and current drain decreasing by 4mA. If the LNA is never required for use, then this pin can be left unconnected or grounded, and Pin 11 is used as the first input.	
4	VDD2	Power supply for the IF buffer amplifier. If the high impedance mixer output is being used, then this pin is not connected.	
5	IF BYP	If this pin is connected to ground, an internal 10pF capacitor is connected in parallel with the mixer output. This capacitor functions as an LO trap, which reduces the amount of LO to IF bleed-through and prevents high LO voltages at the mixer output from degrading the mixer's dynamic range. At higher IF frequencies, this capacitance, along with parasitic layout capacitance, should be parallel resonated out by the choice of the bias inductor value at pin 7. If the internal capacitor is not connected to ground, the buffer amplifier could become unstable. A ~10pF capacitor should be added at the output to maintain the buffer's stability, but the gain will not be significantly affected.	
6	IF2 OUT	$50\Omega$ buffered (open source) output port, one of two output options. Pin 7 must have a bias resistor to V <sub>DD</sub> and pin 6 must have a bias resistor to ground (see Buffered Output Application Schematic) in order to turn the buffer amplifier on. Current drain will increase by approximately 8 mA at 5 V, and by approximately 5 mA at 3 V. It is recommended that these bias resistors be less than $1 \text{k}\Omega$ .	O IF2 OUT
7	IF1 OUT	High impedance (open drain) output port, one of two output options. This pin must be connected to $V_{DD}$ through a resistor or inductor in order to bias the mixer, even when using IF2 Output. In addition, a $0.01\mu\text{F}$ bypass capacitor is required at the other end of the bias resistor or inductor. The ground side of the bypass capacitor should connect immediately to ground plane. This output is intended to drive high impedance IF filters. The recommended matching network is shunt L, series C (see the application schematic, high impedance output). This topology will provide matching, bias, and DC-blocking.	O IF1 OUT
8	LO IN	Mixer LO input. A high-pass matching network, such as a single shunt inductor (as shown in the application schematics), is the recommended topology because it also rejects IF noise at the mixer input. This filtering is required to achieve the specified noise figures. This pin is NOT internally DC-blocked. An external blocking capacitor must be provided if the pin is connected to a device with DC present. A DC path to ground (i.e. an inductor or resistor to ground) is, however, acceptable at this pin. If a blocking capacitor is required, a value of 22pF is recommended.	LO IN
9	RF BYP	Connection for the external bypass capacitor for the mixer RF input preamp. 1000pF is recommended. The trace length between the pin and the capacitor should be minimized. The ground side of the bypass capacitor should connect immediately to ground plane.	

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Pin	Function	Description	Interface Schematic
10	GND	Same as pin 2.	
11	RF IN	Mixer RF Input port. For a $50\Omega$ match at $900$ MHz use a $15$ nH series inductor. This pin is NOT internally DC-blocked. An external blocking capacitor must be provided if the pin is connected to a device with DC present. A DC path to ground (i.e. an inductor or resistor to ground) is, however, acceptable at this pin. If a blocking capacitor is required, a value of $22$ pF is recommended.To minimize the mixer's noise figure, it is recommended to have a RF bandpass filter before this input. This will prevent the noise at the image frequency from being converted to the IF.	RF IN
12	GND	Same as pin 2.	
13	GND	Same as pin 2.	
14	LNA OUT	$50\Omega$ output. Internally DC-blocked.	LINA OUT

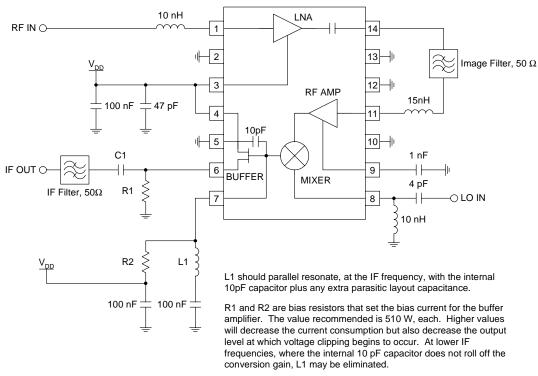
## Application Schematic High Impedance Output Configuration 850MHz



L1 and C1 are picked to match the mixer's output impedance (4 k $\Omega$  II 10 pF) to the IF filter's impedance, at the IF frequency. C1 also serves as a DC block, in case the IF filter is not an open circuit at DC.

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# Application Schematic Buffered Output Configuration 850MHz

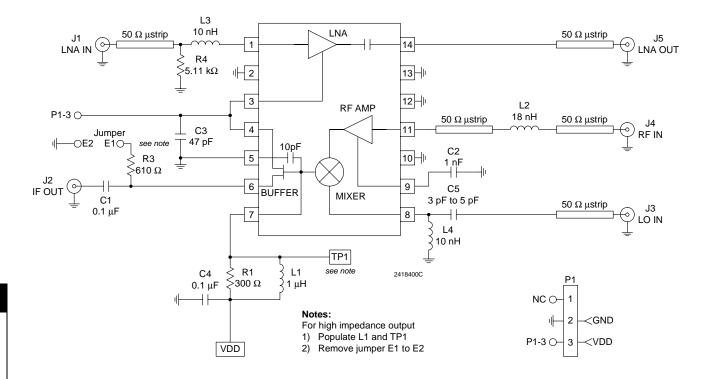


 ${\rm C1}$  is a blocking capacitor, in case the IF filter's input is not an open circuit at DC.

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# Evaluation Board Schematic RF=850MHz, IF=71MHz

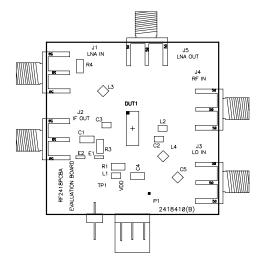
(Download Bill of Materials from www.rfmd.com.)

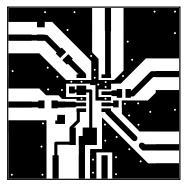


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# Evaluation Board Layout Board Size 1.52" x 1.52"

Board Thickness 0.031", Board Material FR-4



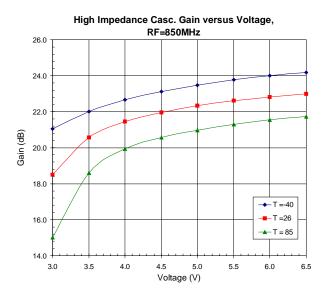


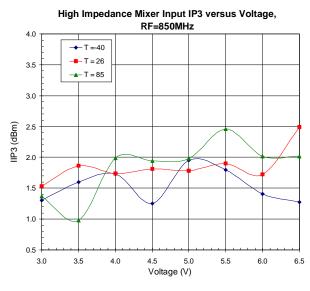
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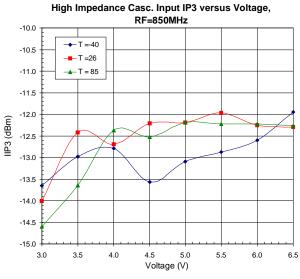
FRONT-ENDS

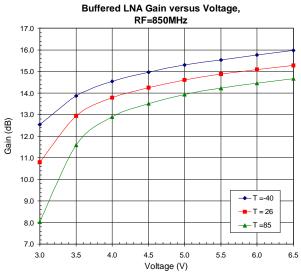
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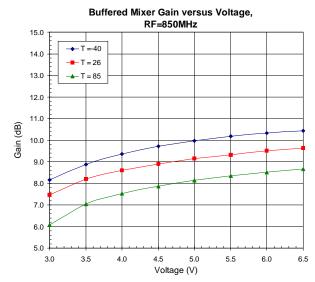
## High Impedance Mixer Gain versus Voltage, RF=850MHz 10.0 9.5 9.0 Gain (dB) 8.0 → T =-40 7.5 **--** T = 26 —**—** T = 85 7.0 3.0 3.5 4.0 5.0 5.5 6.0 6.5 Voltage (V)



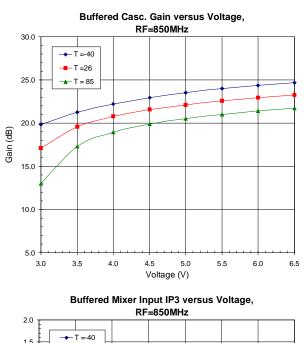


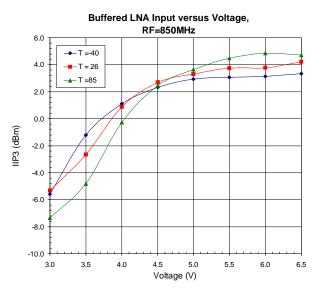


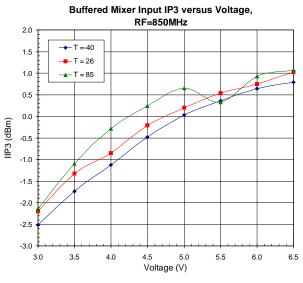


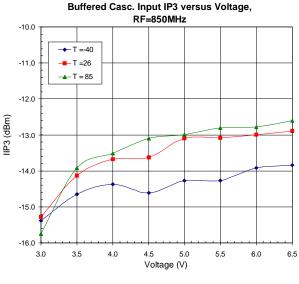


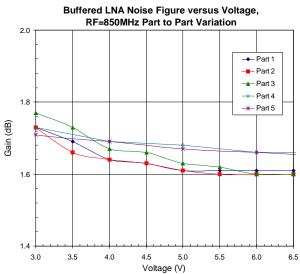
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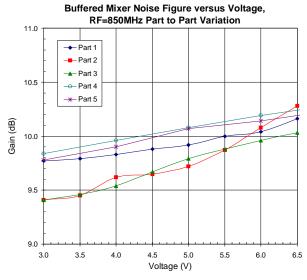












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RONT-ENDS

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